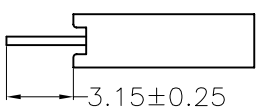
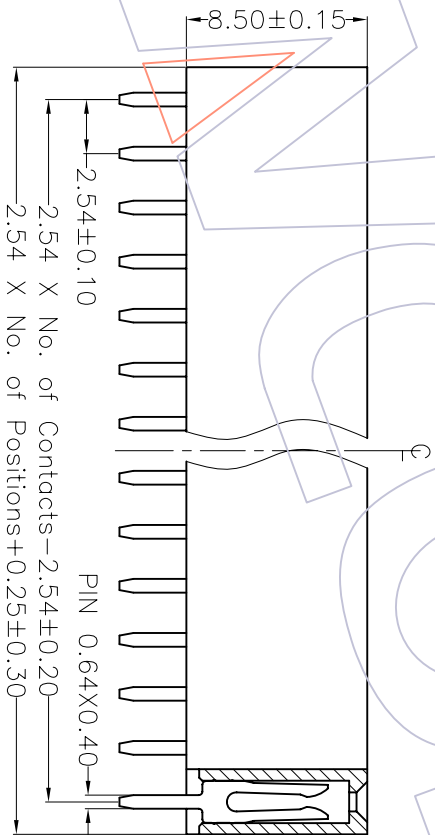
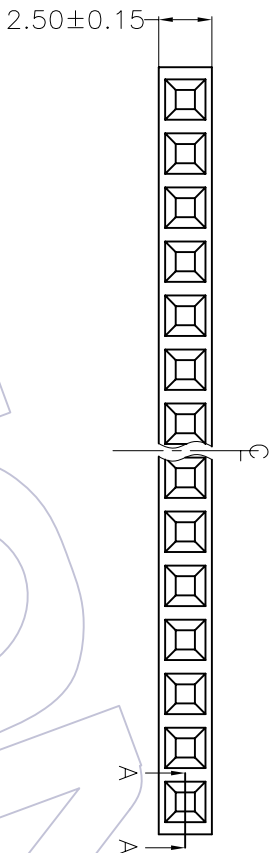
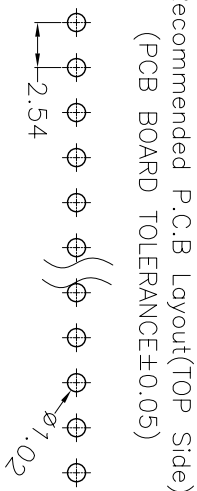


# HSP

### NOTES:

Current Rating: 3.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 1000MΩMin  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze or Brass  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T or PBT+30%G.F UL94V-0



## Ordering Information

2185 - 1 XX S XX X Y N A 1

No of Pins per ROW: 02-40PIN

Contact Plating:  
 GP=Gold Flash  
 G1=3µ"Gold  
 G2=5µ"Gold  
 G3=10µ"Gold  
 G4=15µ"Gold  
 G5=30µ"Gold  
 S0=Gold Flash/Tin  
 S1=3µ"Gold/Tin  
 S2=5µ"Gold/Tin  
 S3=10µ"Gold/Tin  
 S4=15µ"Gold/Tin  
 S5=30µ"Gold/Tin  
 SN=Trim

Insulator:  
 A=PBT  
 C=PA6T

Packing:  
 T=Tube  
 A=Tray

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION		DRAW	WEIXD	SCALE		PART NO.	TITLE:
					Angle	± 3'			UNIT	mm		
A0	08/03/12	NEW			XXX	±0.40	DESIGN	08.03.12	A4	1/1	2185-1XXSXXYYNA1	PH2.54 SINGLE 180° H=8.5
					XXXX	±0.25	CHECK					
					Dim	TOL	APPROVE					

**WCON** 维峰五金电子有限公司  
 WAFER HARDWARE ELECTRONICS CO.,LTD